

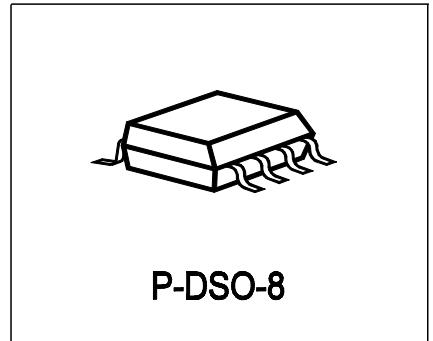
## Smart Power High-Side-Switch

### Features

- Overload protection
- Current limitation
- Short circuit protection
- Thermal shutdown with restart
- Overvoltage protection (including load dump)
- Fast demagnetization of inductive loads
- Reverse battery protection with external resistor
- CMOS compatible input
- Loss of GND and loss of  $V_{bb}$  protection
- ESD - Protection
- Very low standby current

### Product Summary

Overvoltage protection	$V_{bb(AZ)}$	41	V
Operating voltage	$V_{bb(on)}$	5...34	V
On-state resistance	$R_{ON}$	350	mΩ
Nominal load current	$I_{L(nom)}$	0.8	A



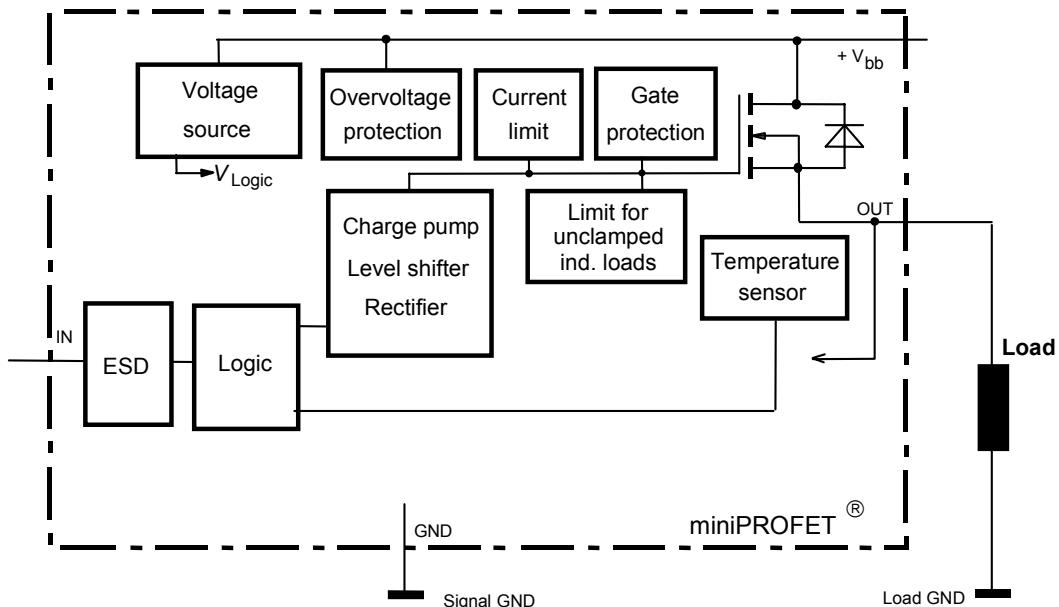
### Application

- All types of resistive, inductive and capacitive loads
- µC compatible power switch for 12 V and 24 V DC applications
- Replaces electromechanical relays and discrete circuits

### General Description

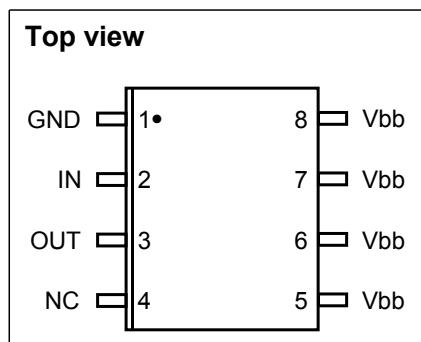
N channel vertical power FET with charge pump, ground referenced CMOS compatible input, monolithically integrated in Smart SIPMOS® technology.  
Providing embedded protective functions.

## Block Diagram



Pin	Symbol	Function
1	GND	Logic ground
2	IN	Input, activates the power switch in case of logic high signal
3	OUT	Output to the load
4	NC	not connected
5	Vbb	Positive power supply voltage
6	Vbb	Positive power supply voltage
7	Vbb	Positive power supply voltage
8	Vbb	Positive power supply voltage

## Pin configuration



**Maximum Ratings at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Value	Unit
Supply voltage	$V_{bb}$	40	V
Supply voltage for full short circuit protection $T_j = -40 \dots +150^\circ\text{C}$	$V_{bb(\text{SC})}$	30	
Continuous input voltage	$V_{IN}$	-10 ... +16	
Load current (Short - circuit current, see page 5)	$I_L$	self limited	A
Current through input pin (DC)	$I_{IN}$	$\pm 5$	mA
Operating temperature	$T_j$	-40 ... +150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 ... +150	
Power dissipation <sup>1)</sup>	$P_{tot}$	1.5	W
Inductive load switch-off energy dissipation <sup>1)2)</sup> single pulse, (see page 8) $T_j = 150^\circ\text{C}, V_{bb} = 13.5\text{ V}, I_L = 0.5\text{ A}$	$E_{AS}$	100	mJ
Load dump protection <sup>2)</sup> $V_{LoadDump}^{3)} = V_A + V_S$ $R_I = 2\Omega, t_d = 400\text{ms}, V_{IN} = \text{low or high}, V_A = 13.5\text{V}$ $R_L = 27\Omega$ $R_L = 45\Omega$	$V_{Loaddump}$	40 60	V
Electrostatic discharge voltage (Human Body Model) according to ANSI EOS/ESD - S5.1 - 1993 ESD STM5.1 - 1998	$V_{ESD}$		kV
Input pin all other pins		$\pm 1$ $\pm 5$	

**Thermal Characteristics**

Thermal resistance @ min. footprint	$R_{th(JA)}$	-	95	-	K/W
Thermal resistance @ 6 cm <sup>2</sup> cooling area <sup>1)</sup>	$R_{th(JA)}$	-	70	83	

<sup>1)</sup>Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70µm thick) copper area for drain connection. PCB is vertical without blown air. (see page 16)

<sup>2)</sup>not subject to production test, specified by design

<sup>3)</sup> $V_{Loaddump}$  is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839 .

Supply voltages higher than  $V_{bb(AZ)}$  require an external current limit for the GND pin, e.g. with a 150Ω resistor in GND connection. A resistor for the protection of the input is integrated.

### Electrical Characteristics

Parameter and Conditions at $T_j = -40\ldots+150^\circ\text{C}$ , $V_{bb} = 13,5\text{V}$ , unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	

### Load Switching Capabilities and Characteristics

On-state resistance $T_j = 25^\circ\text{C}$ , $I_L = 0.5 \text{ A}$ , $V_{bb} = 9\ldots40 \text{ V}$ $T_j = 150^\circ\text{C}$	$R_{ON}$	-	260	350	$\text{m}\Omega$
-	-	450	700		
Nominal load current; Device on PCB <sup>1)</sup> $T_C = 85^\circ\text{C}$ , $T_j \leq 150^\circ\text{C}$	$I_{L(\text{nom})}$	0.8	1.1	-	A
Turn-on time to 90% $V_{OUT}$ $R_L = 47 \Omega$	$t_{on}$	-	-	140	$\mu\text{s}$
Turn-off time to 10% $V_{OUT}$ $R_L = 47 \Omega$	$t_{off}$	-	-	170	
Slew rate on 10 to 30% $V_{OUT}$ , $R_L = 47 \Omega$	$dV/dt_{on}$	-	-	2	$\text{V}/\mu\text{s}$
Slew rate off 70 to 40% $V_{OUT}$ , $R_L = 47 \Omega$	$-dV/dt_{off}$	-	-	2	

### Operating Parameters

Operating voltage	$V_{bb(on)}$	5	-	34	V
Undervoltage shutdown of charge pump	$V_{bb(\text{under})}$	-	-	5	
Undervoltage restart of charge pump	$V_{bb(u\ cp)}$	-	-	5.5	
Standby current $T_j = -40\ldots+85^\circ\text{C}$ , $V_{IN} = 0 \text{ V}$ $T_j = 150^\circ\text{C}^2$ , $V_{IN} = 0 \text{ V}$	$I_{bb(off)}$	-	-	12	$\mu\text{A}$
-	-	-	-	17	
Leakage output current (included in $I_{bb(off)}$ ) $V_{IN} = 0 \text{ V}$	$I_{L(\text{off})}$	-	-	5	
Operating current $V_{IN} = 5 \text{ V}$	$I_{GND}$	-	-	1	$\text{mA}$

<sup>1</sup>Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70µm thick) copper area for drain connection. PCB is vertical without blown air. (see page 16)

<sup>2</sup>higher current due temperature sensor

### Electrical Characteristics

Parameter and Conditions at $T_j = -40 \dots +150^\circ\text{C}$ , $V_{bb} = 13,5\text{V}$ , unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	
<b>Protection Functions<sup>1)</sup></b>					
Initial peak short circuit current limit (pin 5 to 3) $T_j = -40^\circ\text{C}$ , $V_{bb} = 20\text{ V}$	$I_{L(SCp)}$	-	-	8	A
$T_j = 25^\circ\text{C}$		-	4	-	
$T_j = 150^\circ\text{C}$		2	-	-	
Repetitive short circuit current limit $T_j = T_{jt}$ (see timing diagrams)	$I_{L(SCr)}$	-	3	-	
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$ , $I_{bb} = 4\text{ mA}$	$V_{ON(CL)}$	41	47	-	V
Overvoltage protection <sup>2)</sup> $I_{bb} = 4\text{ mA}$	$V_{bb(AZ)}$	41	-	-	
Thermal overload trip temperature	$T_{jt}$	150	-	-	$^\circ\text{C}$
Thermal hysteresis	$\Delta T_{jt}$	-	10	-	K

### Reverse Battery

Reverse battery <sup>3)</sup>	$-V_{bb}$	-	-	32	V
Drain-source diode voltage ( $V_{OUT} > V_{bb}$ ) $T_j = 150^\circ\text{C}$	$-V_{ON}$	-	600	-	mV

<sup>1</sup>Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

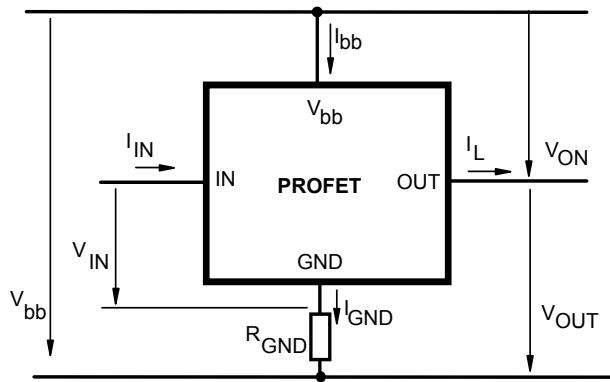
<sup>2</sup> see also  $V_{ON(CL)}$  in circuit diagram on page 7

<sup>3</sup>Requires a  $150\Omega$  resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Power dissipation is higher compared to normal operating conditions due to the voltage drop across the drain-source diode. The temperature protection is not active during reverse current operation! Input current has to be limited (see max. ratings page 3).

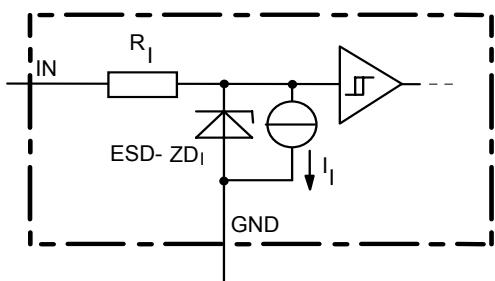
**Electrical Characteristics**

<b>Parameter and Conditions</b> at $T_j = -40\ldots+150^\circ\text{C}$ , $V_{bb} = 13,5\text{V}$ , unless otherwise specified	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>
		<b>min.</b>	<b>typ.</b>	<b>max.</b>	
<b>Input</b>					
Input turn-on threshold voltage (see page 12)	$V_{IN(T+)}$	-	-	2.2	V
Input turn-off threshold voltage (see page 12)	$V_{IN(T-)}$	0.8	-	-	
Input threshold hysteresis	$\Delta V_{IN(T)}$	-	0.3	-	
Off state input current (see page 12) $V_{IN} = 0.7\text{ V}$	$I_{IN(off)}$	1	-	30	$\mu\text{A}$
On state input current (see page 12) $V_{IN} = 5\text{ V}$	$I_{IN(on)}$	1	-	30	
Input resistance (see page 6)	$R_I$	1.5	3.5	5	$\text{k}\Omega$

## Terms

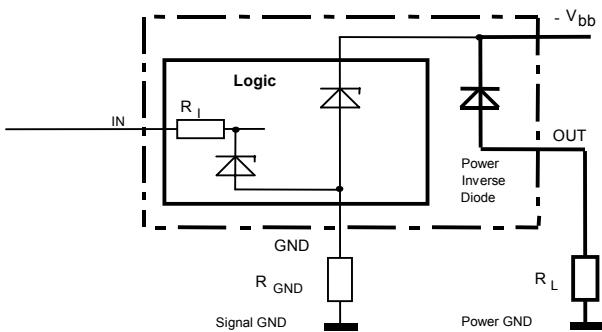


## Input circuit (ESD protection)



The use of ESD zener diodes as voltage clamp at DC conditions is not recommended

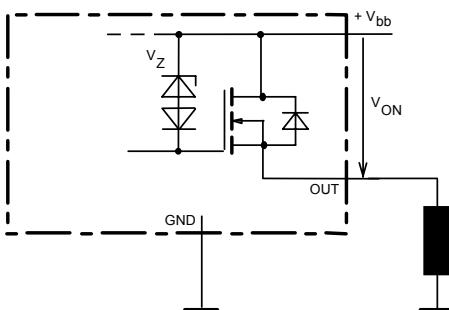
## Reverse battery protection



$R_{GND}=150\Omega$ ,  $R_I=3.5k\Omega$  typ.,

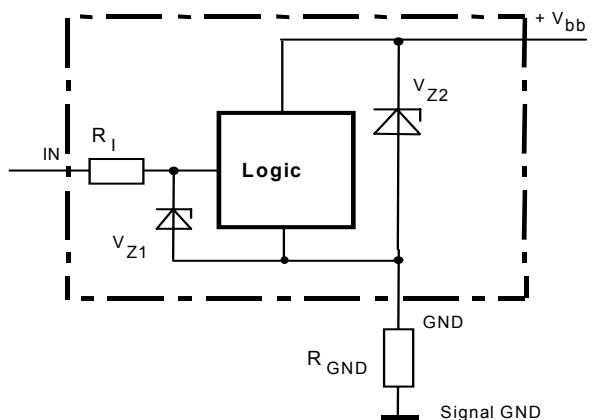
Temperature protection is not active during inverse current

## Inductive and overvoltage output clamp

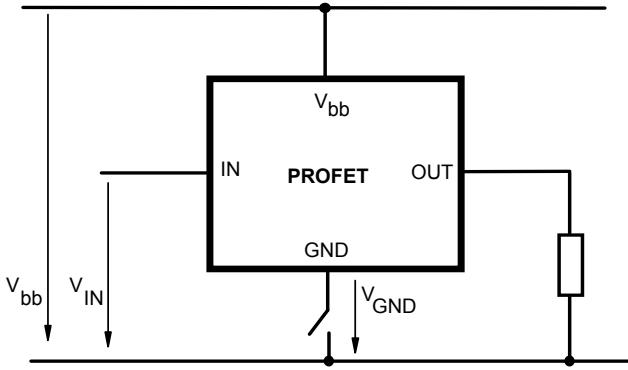
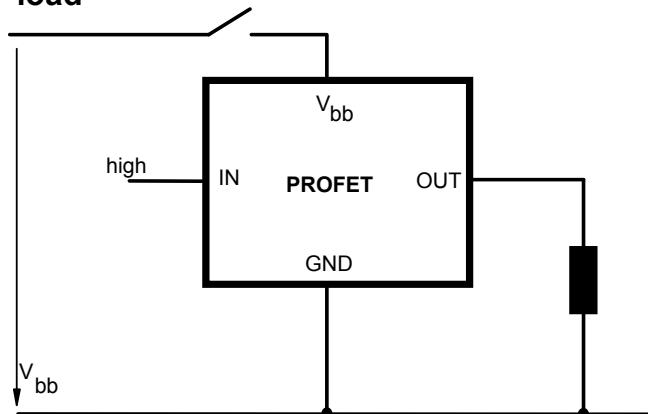
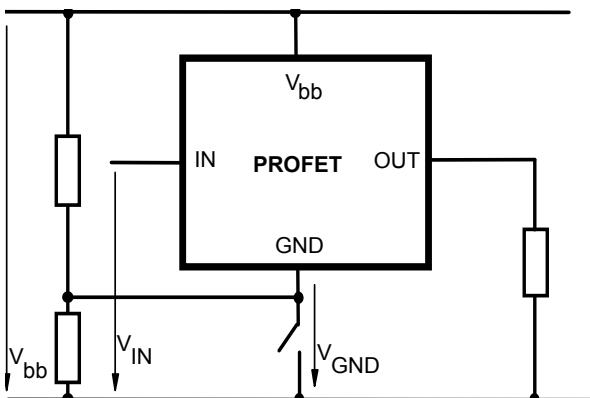
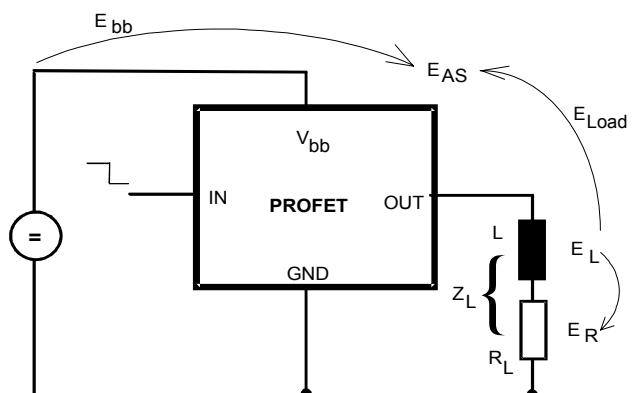


$V_{ON}$  clamped to 47V typ.

## Overvoltage protection of logic part



$V_{Z1}=6.1V$  typ.,  $V_{Z2}=V_{bb(AZ)}=47V$  typ.,  
 $R_I=3.5 k\Omega$  typ.,  $R_{GND}=150\Omega$

**GND disconnect**

 **$V_{bb}$  disconnect with charged inductive load**

**GND disconnect with GND pull up**

**Inductive Load switch-off energy dissipation**


Energy stored in load inductance:  $E_L = \frac{1}{2} * L * I_L^2$

While demagnetizing load inductance,

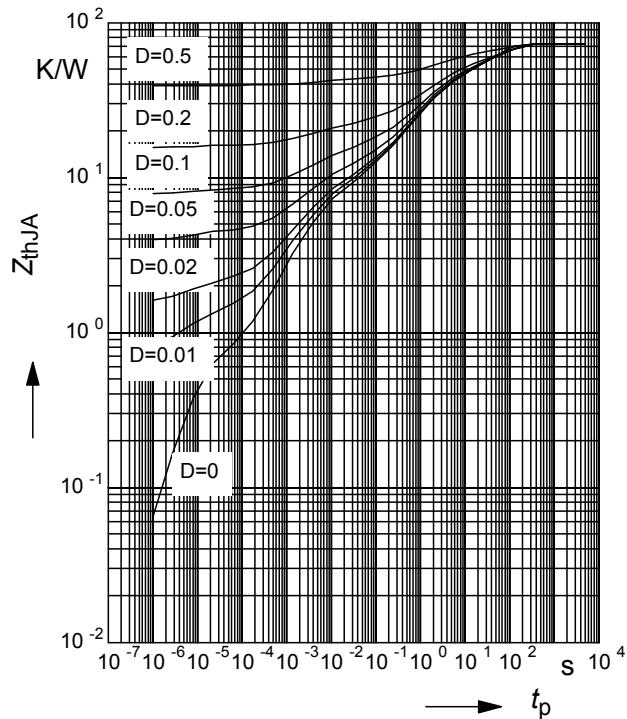
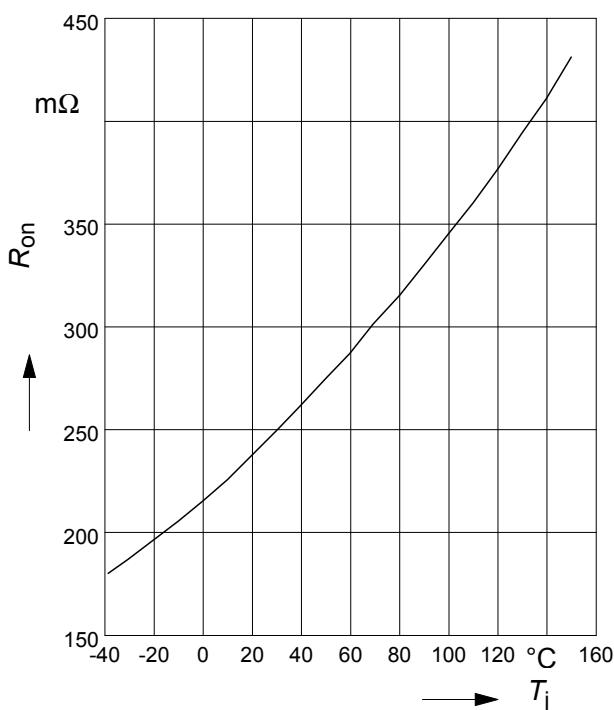
the energy dissipated in PROFET is

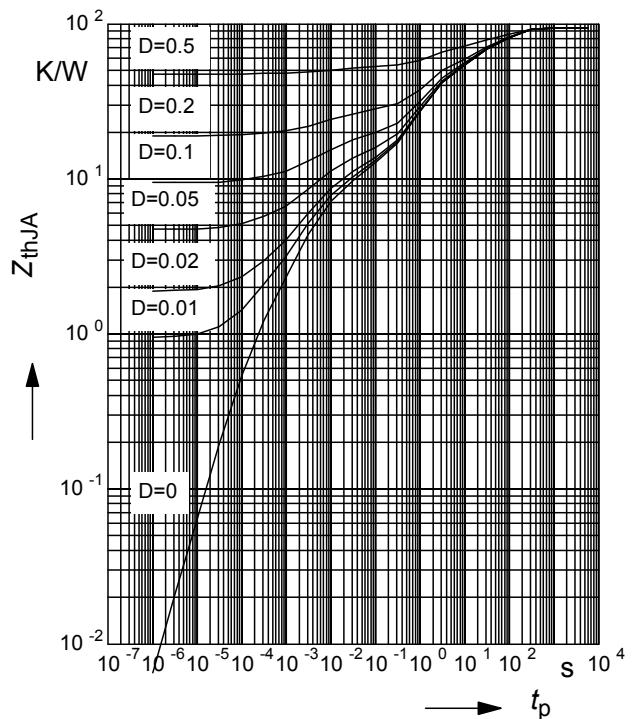
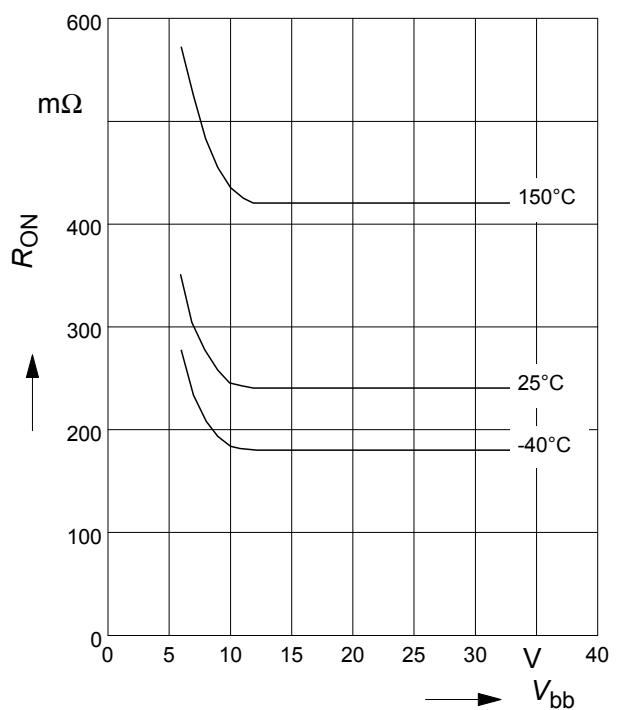
$$E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} * i_L(t) dt,$$

with an approximate solution for  $R_L > 0\Omega$ :

$$E_{AS} = \frac{I_L * L}{2 * R_L} * (V_{bb} + |V_{OUT(CL)}|) * \ln(1 + \frac{I_L * R_L}{|V_{OUT(CL)}|})$$

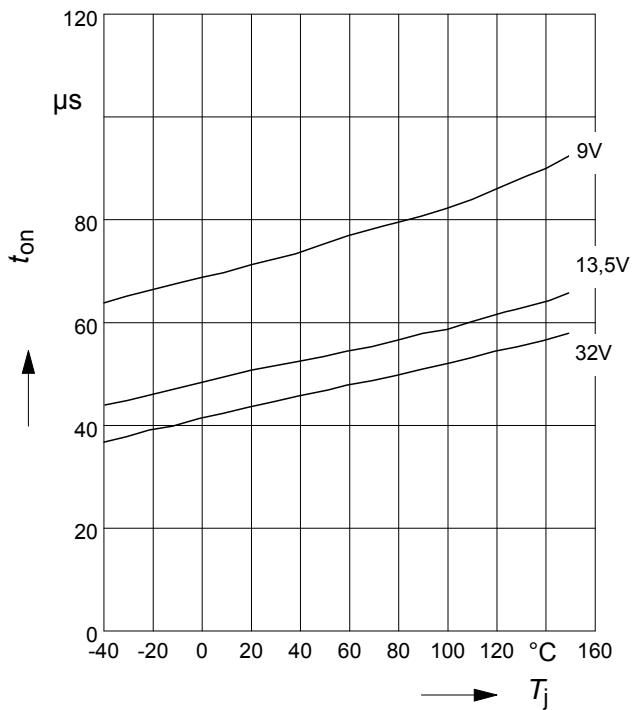
**Typ. transient thermal impedance**
 $Z_{thJA} = f(t_p) @ 6\text{cm}^2 \text{ heatsink area}$ 

Parameter:  $D = t_p/T$ 

**Typ. on-state resistance**
 $R_{ON} = f(T_j) ; V_{bb} = 13.5V ; V_{in} = \text{high}$ 

**Typ. transient thermal impedance**
 $Z_{thJA} = f(t_p) @ \text{min. footprint}$ 

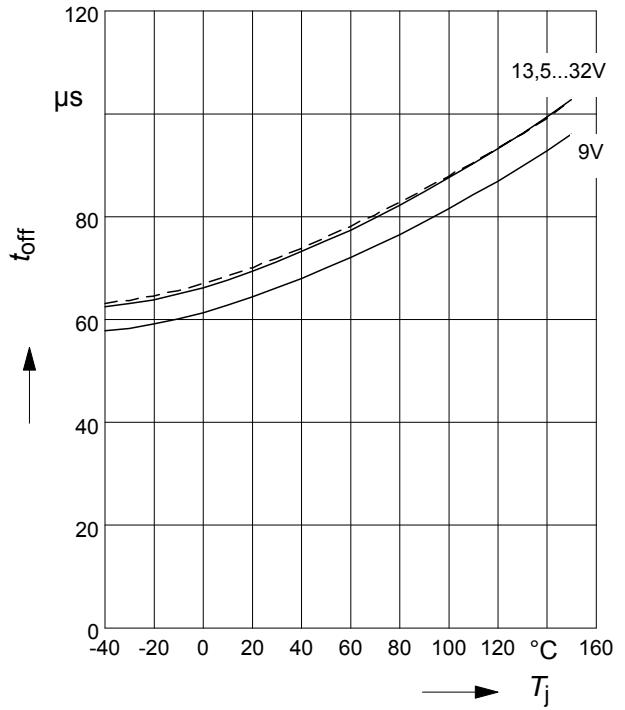
Parameter:  $D = t_p/T$ 

**Typ. on-state resistance**
 $R_{ON} = f(V_{bb}) ; I_L = 0.5A ; V_{in} = \text{high}$ 


**Typ. turn on time**

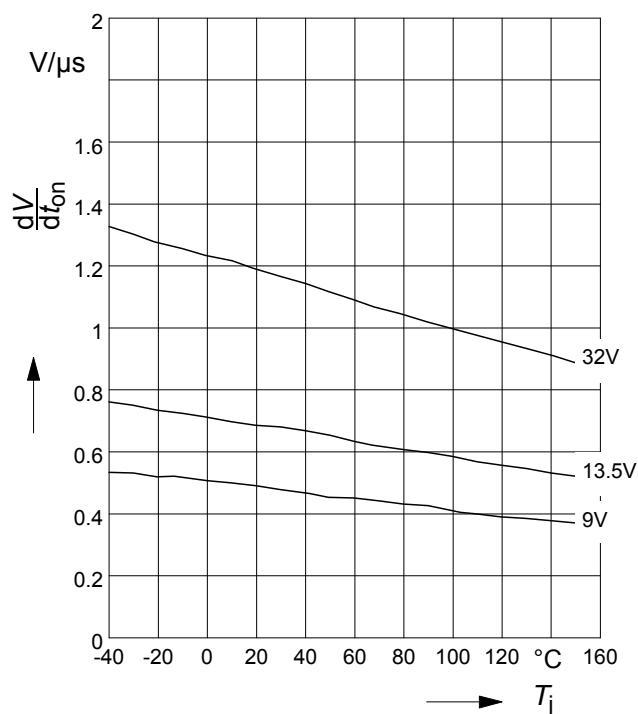
$$t_{\text{on}} = f(T_j); R_L = 47\Omega$$


**Typ. turn off time**

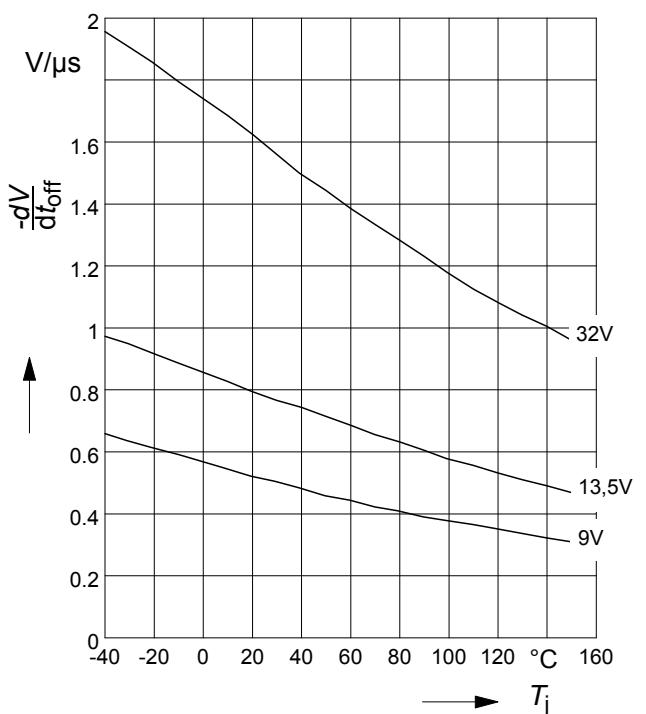
$$t_{\text{off}} = f(T_j); R_L = 47\Omega$$


**Typ. slew rate on**

$$dV/dt_{\text{on}} = f(T_j); R_L = 47 \Omega$$

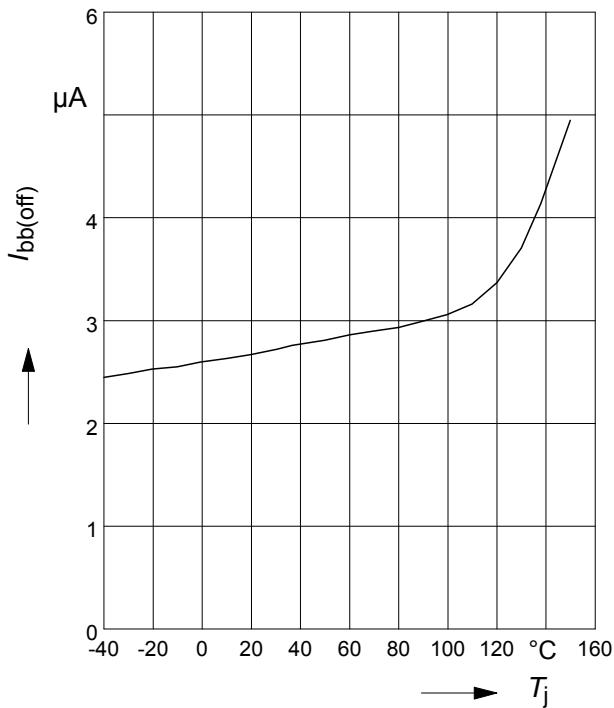

**Typ. slew rate off**

$$dV/dt_{\text{off}} = f(T_j); R_L = 47 \Omega$$

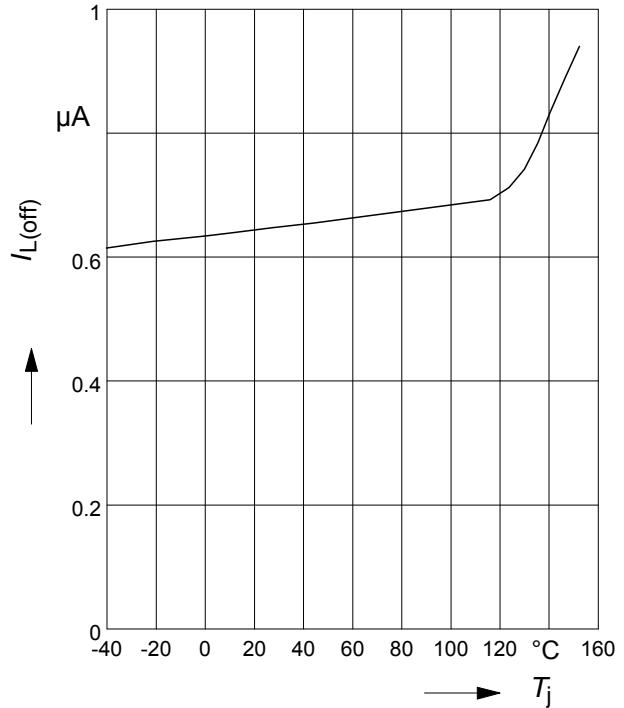


**Typ. standby current**

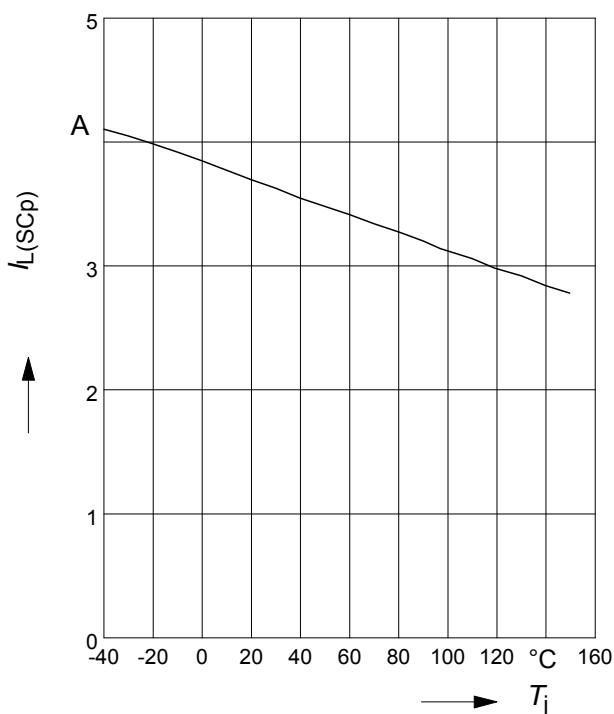
$$I_{bb(off)} = f(T_j) ; V_{bb} = 32V ; V_{IN} = \text{low}$$


**Typ. leakage current**

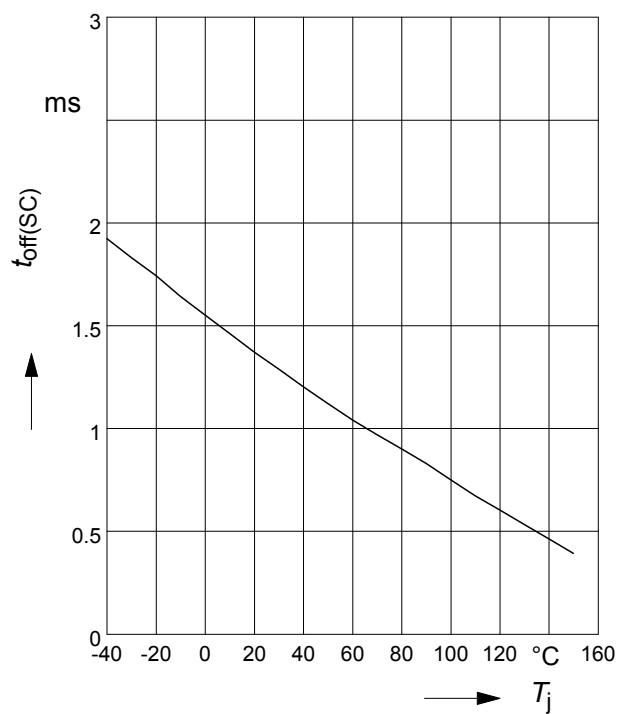
$$I_{L(off)} = f(T_j) ; V_{bb} = 32V ; V_{IN} = \text{low}$$


**Typ. initial peak short circuit current limit**

$$I_{L(SCp)} = f(T_j) ; V_{bb} = 20V$$


**Typ. initial short circuit shutdown time**

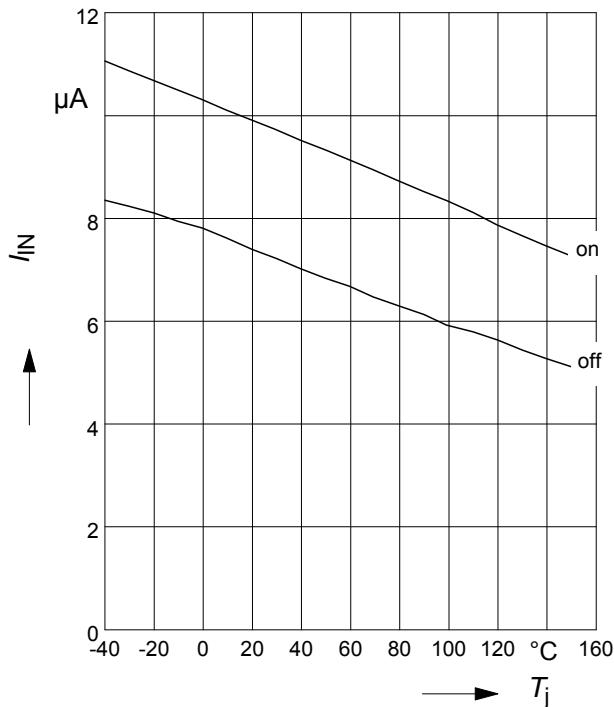
$$t_{off(SC)} = f(T_{j,start}) ; V_{bb} = 20V$$



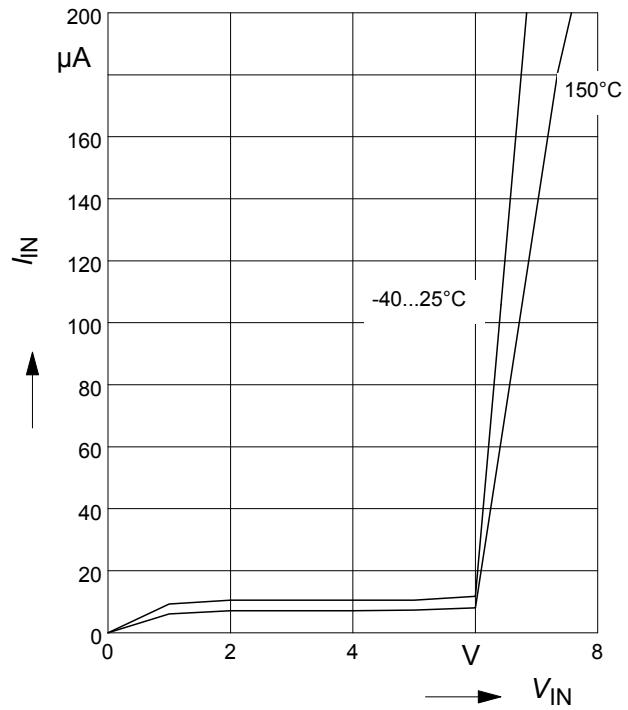
**Typ. input current**

$$I_{IN(on/off)} = f(T_j); V_{bb} = 13.5V; V_{IN} = \text{low/high}$$

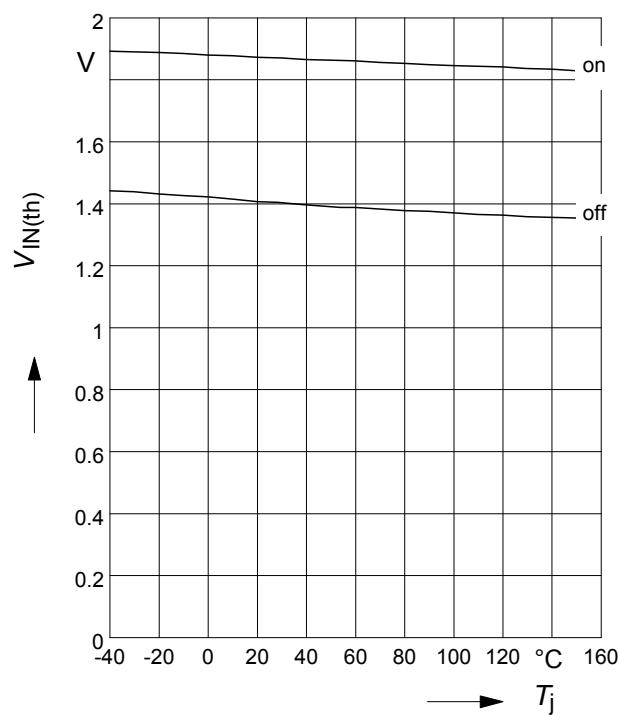
$$V_{IN\text{low}} \leq 0.7V; V_{IN\text{high}} = 5V$$


**Typ. input current**

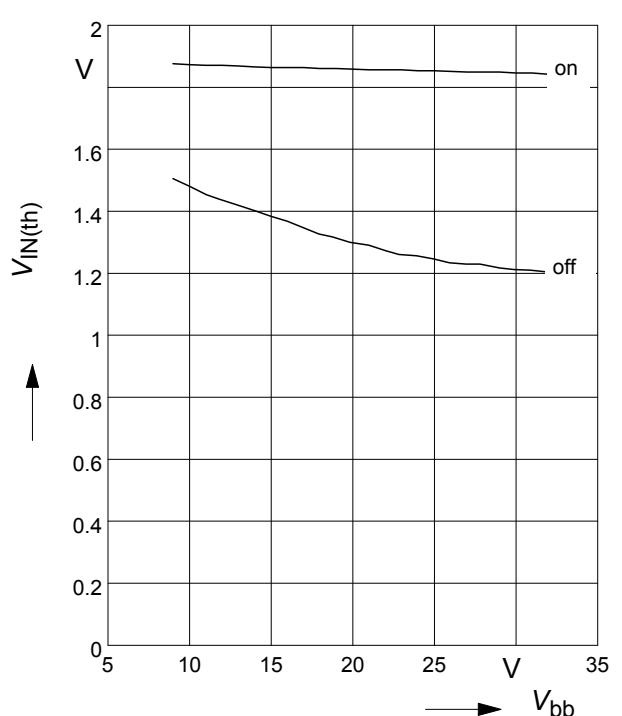
$$I_{IN} = f(V_{IN}); V_{bb} = 13.5V$$


**Typ. input threshold voltage**

$$V_{IN(th)} = f(T_j); V_{bb} = 13.5V$$

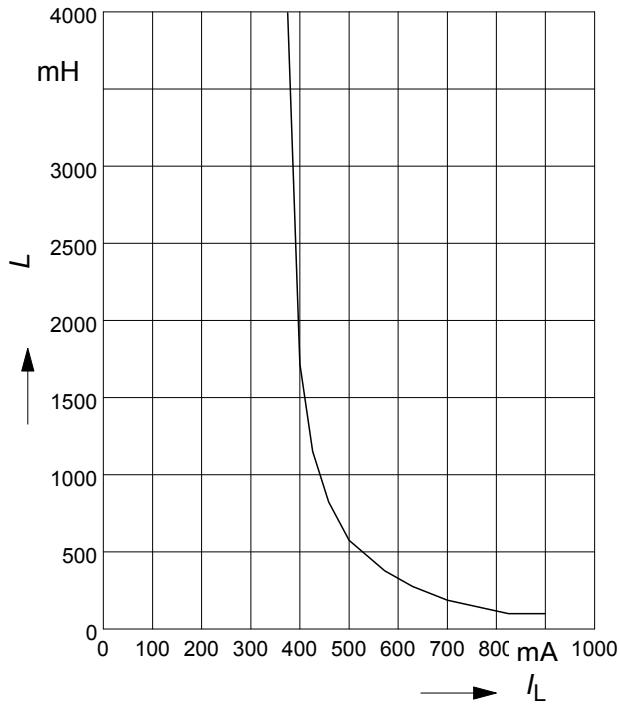

**Typ. input threshold voltage**

$$V_{IN(th)} = f(V_{bb}); T_j = 25^{\circ}\text{C}$$



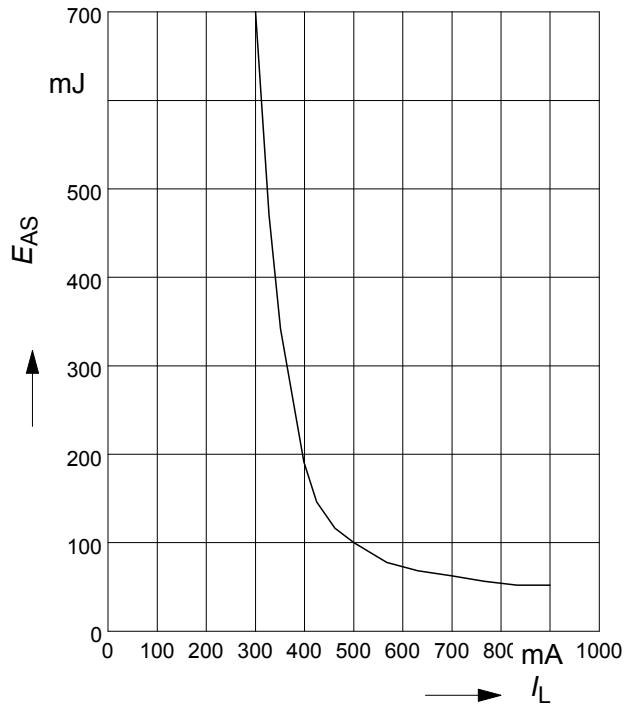
**Maximum allowable load inductance  
for a single switch off**

$$L = f(I_L); \quad T_{jstart} = 150^\circ\text{C}, \quad V_{bb} = 13.5\text{V}, \quad R_L = 0\Omega$$



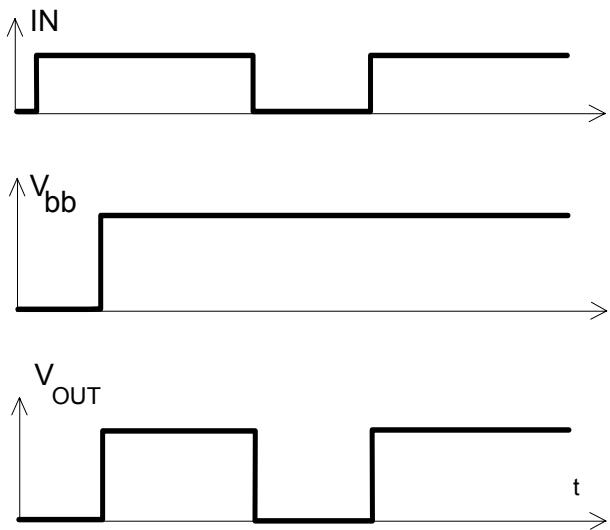
**Maximum allowable inductive switch-off  
energy, single pulse**

$$E_{AS} = f(I_L); \quad T_{jstart} = 150^\circ\text{C}, \quad V_{bb} = 13.5\text{V}$$

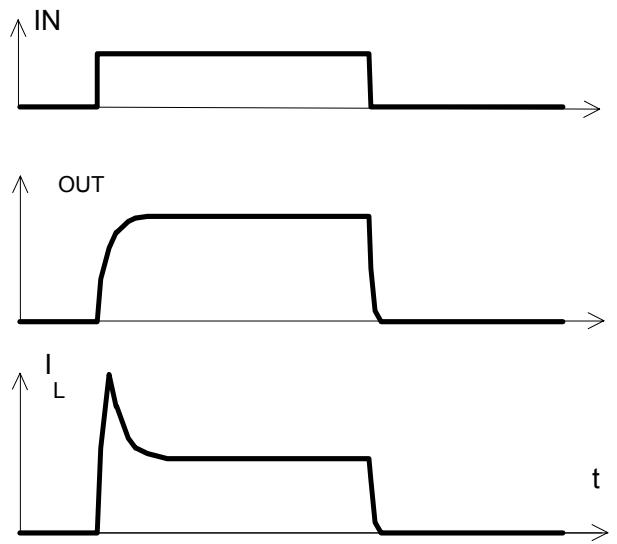


## Timing diagrams

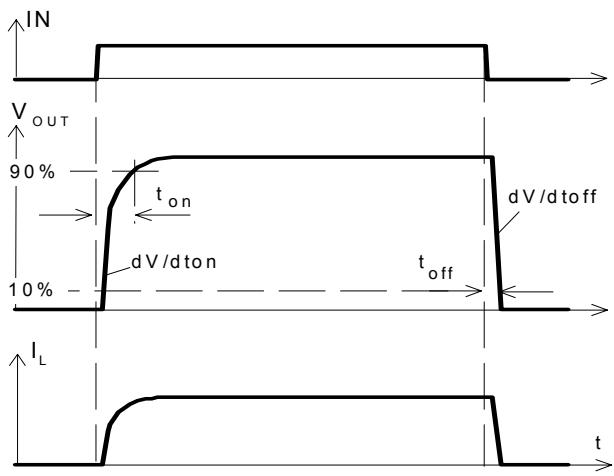
**Figure 1a:** V<sub>bb</sub> turn on:



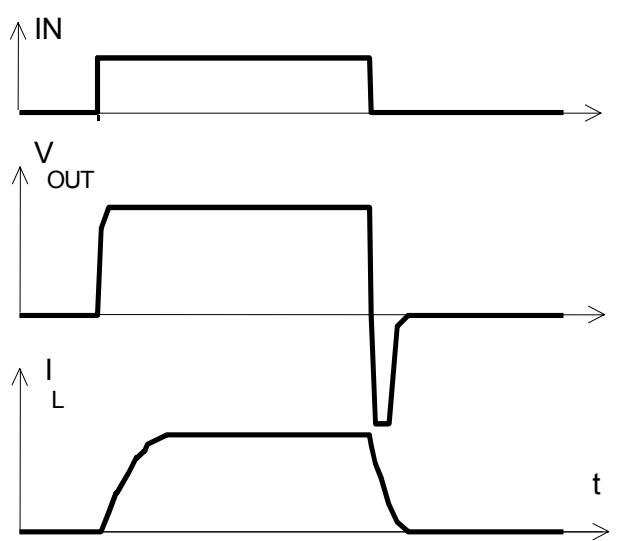
**Figure 2b:** Switching a lamp,



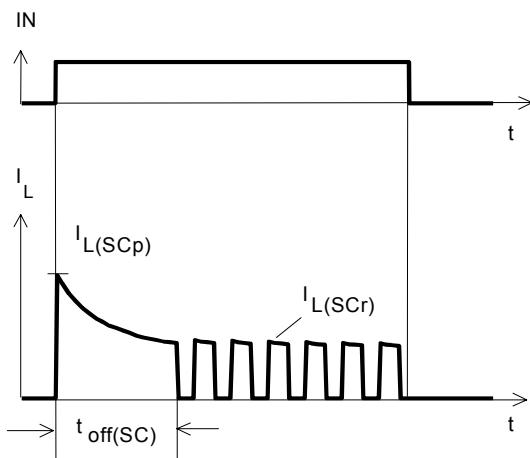
**Figure 2a:** Switching a resistive load,  
turn-on/off time and slew rate definition



**Figure 2c:** Switching an inductive load



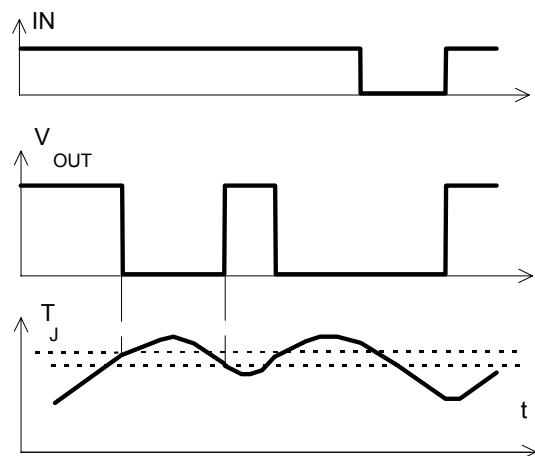
**Figure 3a:** Turn on into short circuit, shut down by overtemperature, restart by cooling



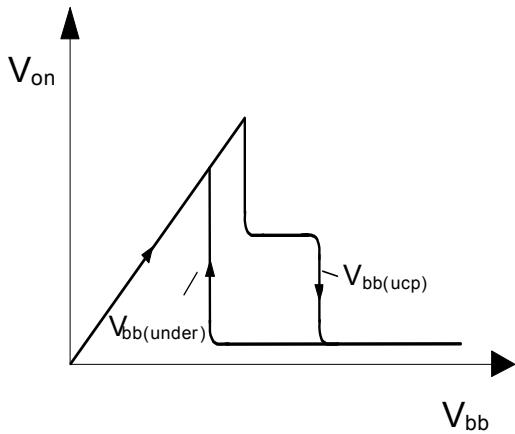
Heating up of the chip may require several milliseconds, depending on external conditions.

**Figure 4:** Overtemperature:

Reset if  $T_j < T_{jt}$



**Figure 5:** Undervoltage restart of charge pump

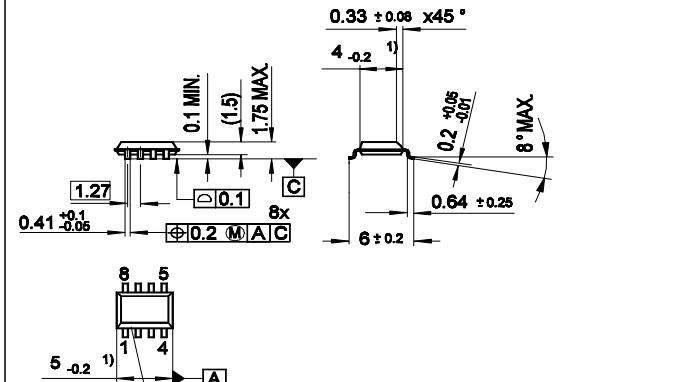


## **Package and ordering code**

all dimensions in mm

### Package:

### Ordering code:

P-DSO-8-6	Q67060-S7300-A2
 <p>Technical drawing of the P-DSO-8-6 package showing top view dimensions and index marking. Dimensions include: Top thickness: 0.41<sup>+0.1</sup><sub>-0.05</sub> mm; Side height: 1.27 mm; Total height: 1.75 MAX mm; Lead height: 0.1 mm; Lead width: 0.2 mm; Lead pitch: 8x mm; Lead angle: 8° MAX; Lead thickness: 0.64 ± 0.25 mm; Lead width at base: 0.33 ± 0.08 x 45°; Lead height at base: 0.2 ± 0.05 mm; Index Marking (Chamfer) at bottom left.</p> <p>1) Does not include plastic or metal protrusion of 0.15 max. per side</p>	

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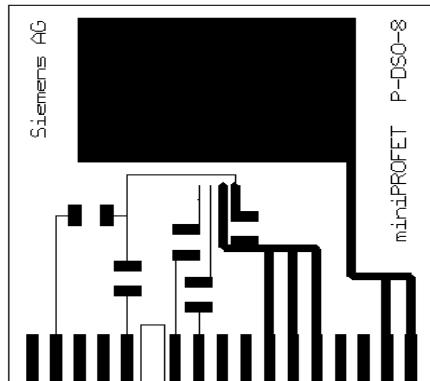
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Printed circuit board (FR4, 1.5mm thick, one layer 70µm, 6cm<sup>2</sup> active heatsink area ) as a reference for max. power dissipation  $P_{tot}$  nominal load current  $I_{L(nom)}$  and thermal resistance  $R_{thja}$



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

#### Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помошь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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